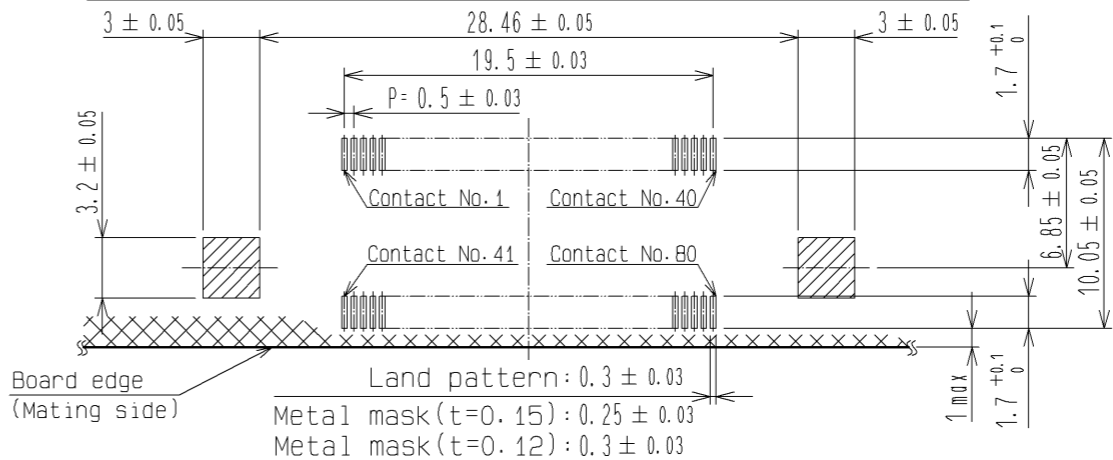
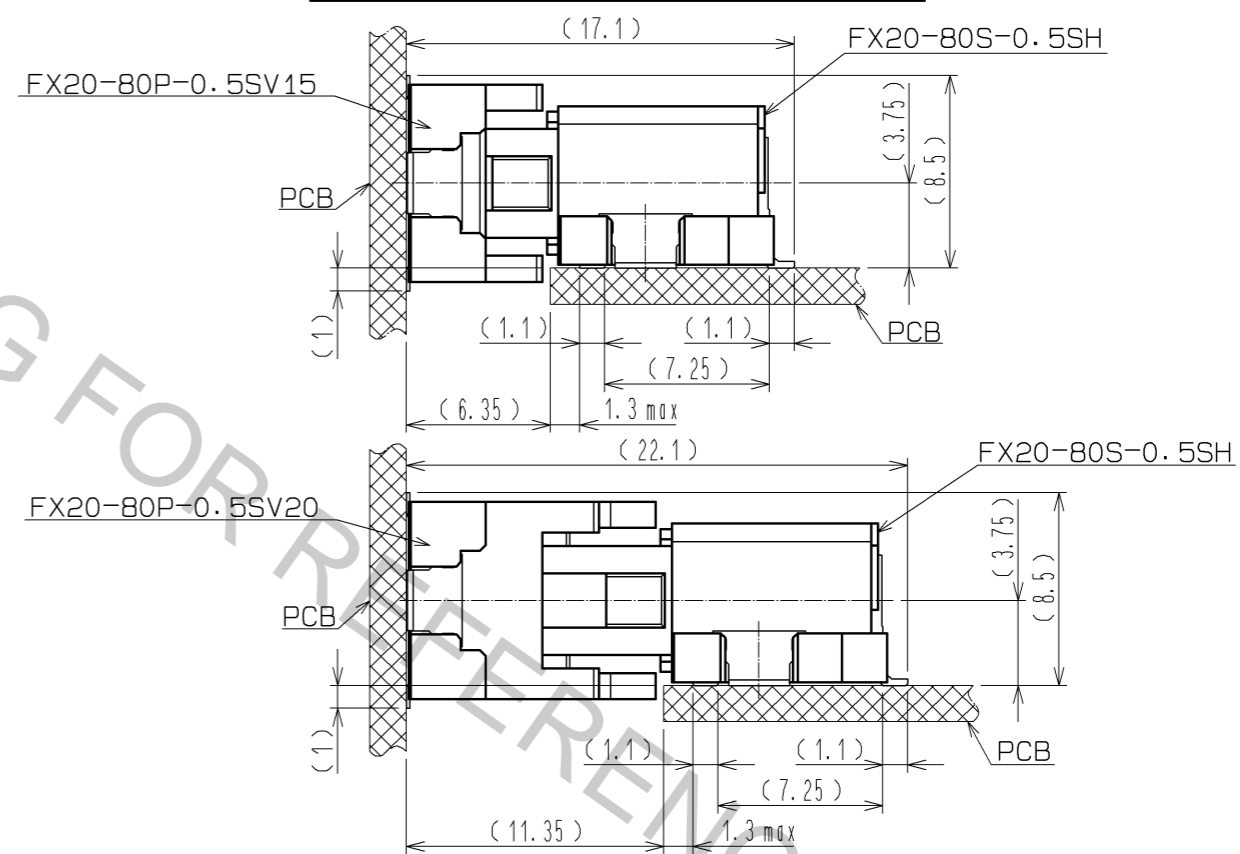


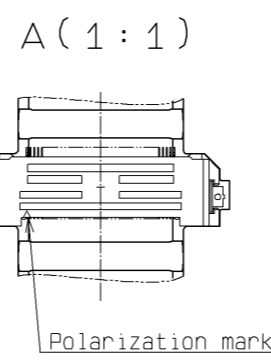
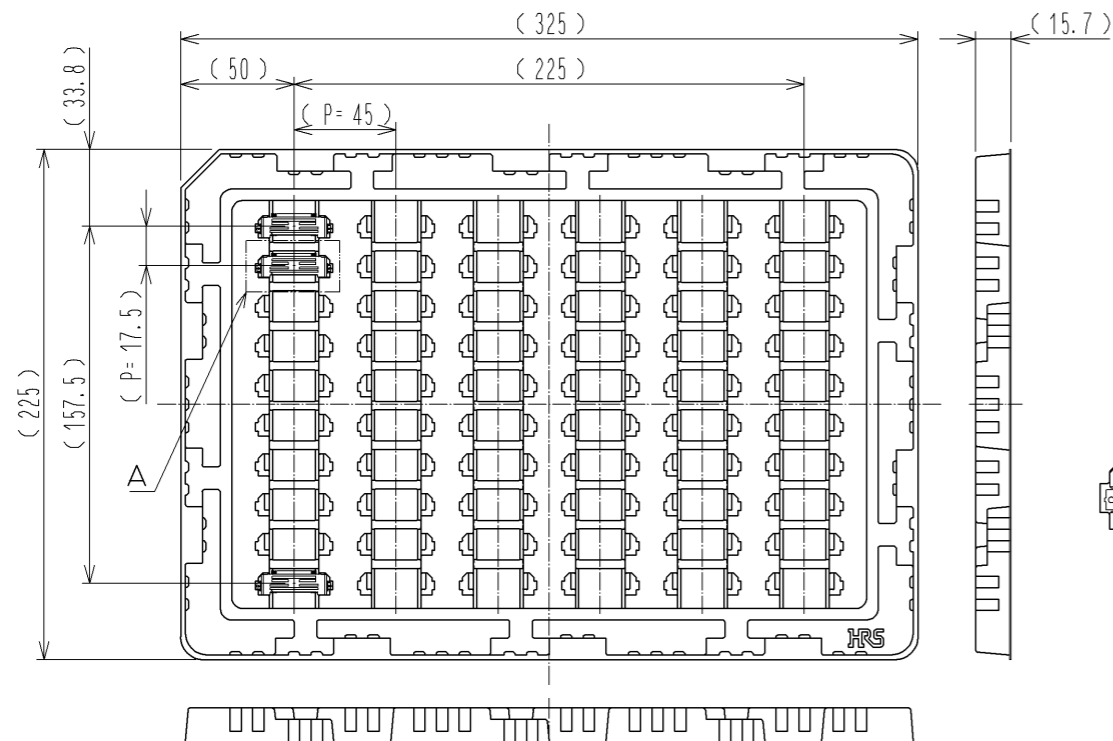
5 Recommended land pattern dimension of PCB



Drawing for mating(No scale)



2 Drawing for packing(No scale)



- 1 Lead CO-Planarity is 0.1mm MAX.
- 2 This is packaged in tray. (60pcs/tray)
- 3 Blemish and hit mark can be occurred through out the manufacturing process which dosen't affect quality level.
- 4 Please note that excessive wrenching force could damage this connector. Please refer to the guideline for detailed regulations of the mating method.
- 5 No prohibited area for printing pattern or via hole. PCB resist can be printed optionally.
- 6 The dimensions in parentheses are for references.

1		LCP	BLACK UL94V-0	4		BRASS	TIN-PLATING 1 μm
2, 3		PHOSPHOR BRONZE					CONTACT AREA:GOLD 0.1 μm
							LEAD AREA:GOLD 0.03 μm
							UNDER PLATING:NICKEL 1 μm
NO.	MATERIAL	FINISH , REMARKS		NO.	MATERIAL	FINISH , REMARKS	
UNITS	mm	SCALE	COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED
		2 : 1	△				DATE
HRS		HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA	13.09.25	DRAWING NO. EDC3-348428-00	
				CHECKED : KI. HIROKAWA	13.09.25	PART NO. FX20-80S-0.5SH	
				DESIGNED : TS. OONO	13.09.25	CODE NO. CL570-1603-3-00	
				DRAWN : TS. OONO	13.09.25		